

MOS FIELD EFFECT TRANSISTOR

μ PA1716

SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

勝特力材料 886-3-5753170
 勝特力电子(上海) 86-21-34970699
 勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

DESCRIPTION

This product is P-Channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

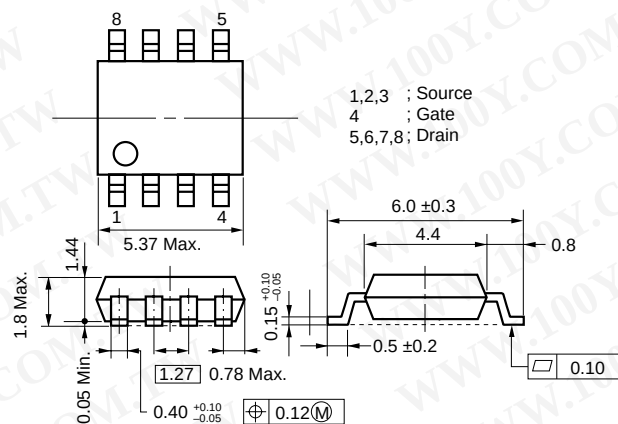
FEATURES

- Low on-resistance
 $R_{DS(on)1} = 12.5 \text{ m}\Omega$ TYP. ($V_{GS} = -10 \text{ V}$, $I_D = -4 \text{ A}$)
 $R_{DS(on)2} = 17.0 \text{ m}\Omega$ TYP. ($V_{GS} = -4.5 \text{ V}$, $I_D = -4 \text{ A}$)
 $R_{DS(on)3} = 19.0 \text{ m}\Omega$ TYP. ($V_{GS} = -4.0 \text{ V}$, $I_D = -4 \text{ A}$)
- Low C_{iss} : $C_{iss} = 2100 \text{ pF}$ TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA1716G	Power SOP8

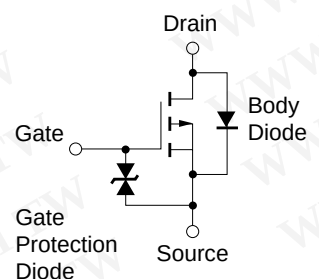
PACKAGE DRAWING (Unit : mm)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, All terminals are connected.)

Drain to Source Voltage ($V_{GS} = 0 \text{ V}$)	V_{DSS}	-30	V
Gate to Source Voltage ($V_{DS} = 0 \text{ V}$)	V_{GSS}	± 20	V
Drain Current (DC)	$I_{D(DC)}$	± 8	A
Drain Current (pulse) ^{Note1}	$I_{D(pulse)}$	± 32	A
Total Power Dissipation ($T_A = 25^\circ\text{C}$) ^{Note2}	P_T	2.0	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

EQUIVALENT CIRCUIT



- Notes 1.** $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$
2. Mounted on ceramic substrate of $1200 \text{ mm}^2 \times 1.0 \text{ mm}$

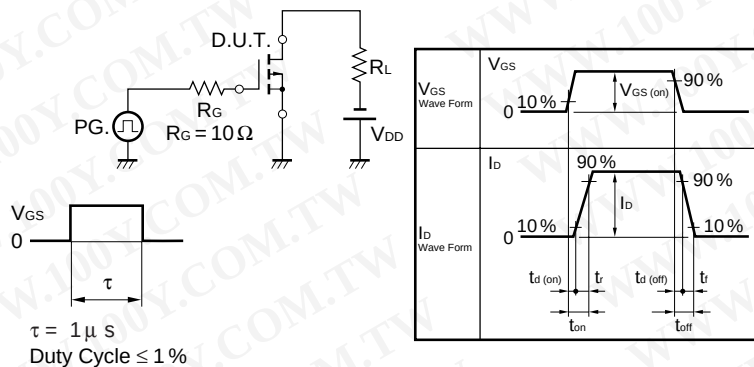
Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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 Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

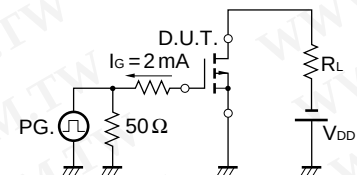
ELECTRICAL CHARACTERISTICS (T_A = 25 °C, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	R _{DS(on)1}	V _{GS} = -10 V, I _D = -4.0 A		12.5	16	mΩ
	R _{DS(on)2}	V _{GS} = -4.5 V, I _D = -4.0 A		17	23	mΩ
	R _{DS(on)3}	V _{GS} = -4.0 V, I _D = -4.0 A		19	26	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = -10 V, I _D = -1 mA	-1.0	-1.6	-2.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = -10 V, I _D = -4.0 A	7	14		S
Drain Leakage Current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V			-1	μA
Gate to Source Leakage Current	I _{GSS}	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μA
Input Capacitance	C _{iss}	V _{DS} = -10 V		2100		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V		700		pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		300		pF
Turn-on Delay Time	t _{d(on)}	I _D = -4.0 A		30		ns
Rise Time	t _r	V _{GS(on)} = -10 V		150		ns
Turn-off Delay Time	t _{d(off)}	V _{DD} = -15 V		120		ns
Fall Time	t _f	R _G = 10 Ω		76		ns
Total Gate Charge	Q _G	I _D = -8.0 A		40		nC
Gate to Source Charge	Q _{GS}	V _{DD} = -24 V		6		nC
Gate to Drain Charge	Q _{GD}	V _{GS} = -10 V		10		nC
Body Diode Forward Voltage	V _{F(S-D)}	I _F = 8.0 A, V _{GS} = 0 V		0.8		V
Reverse Recovery Time	t _{rr}	I _F = 8.0 A, V _{GS} = 0 V		45		ns
Reverse Recovery Charge	Q _{rr}	di/dt = 100 A/μs		33		nC

TEST CIRCUIT 1 SWITCHING TIME



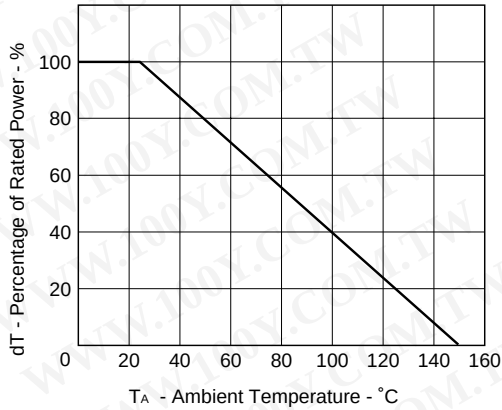
TEST CIRCUIT 2 GATE CHARGE



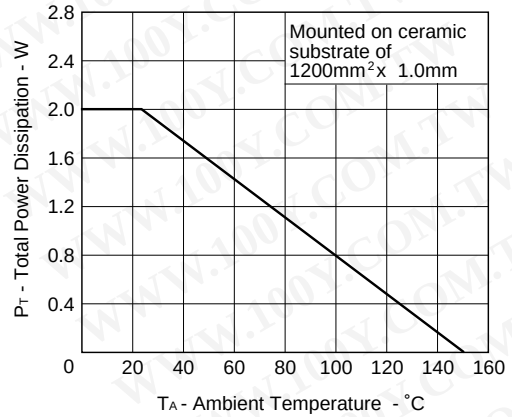
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TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

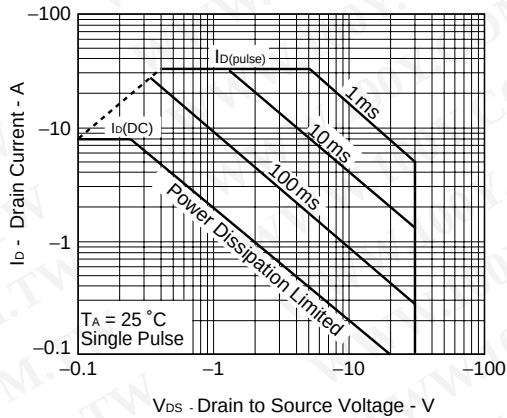
DERATING FACTOR OF FORWARD BIAS
SAFE OPERATING AREA



TOTAL POWER DISSIPATION vs.
AMBIENT TEMPERATURE



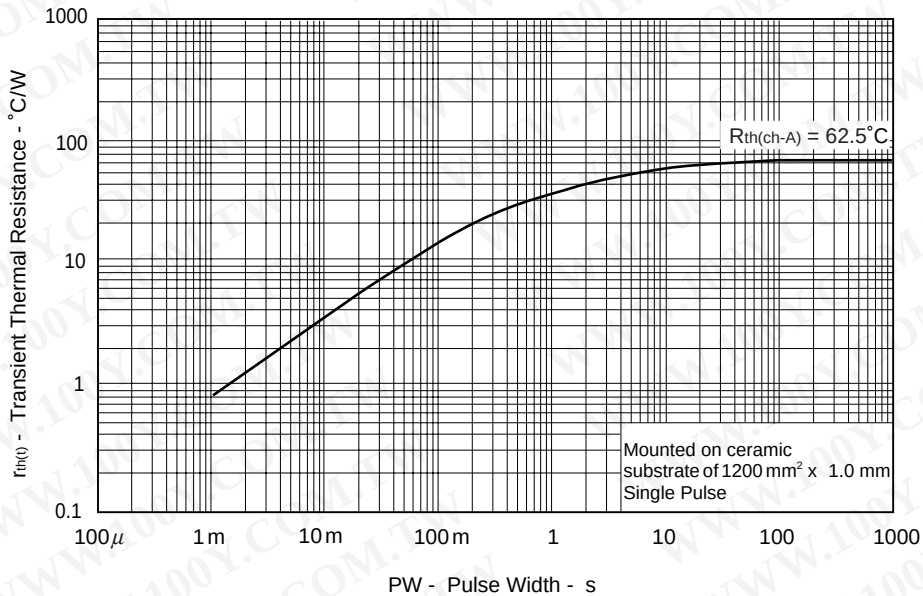
FORWARD BIAS SAFE OPERATING AREA



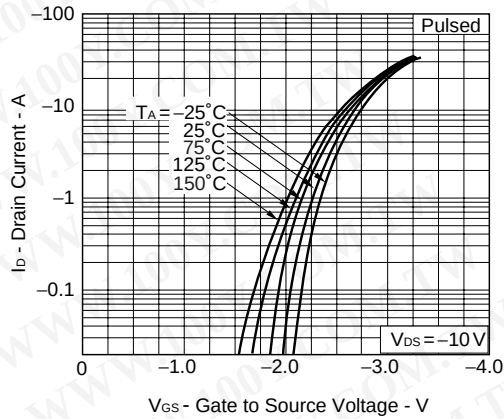
Remark Mounted on ceramic substrate of
1200 mm² x 1.0 mm

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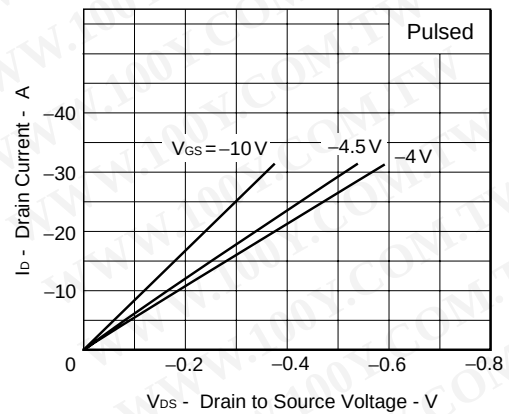
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



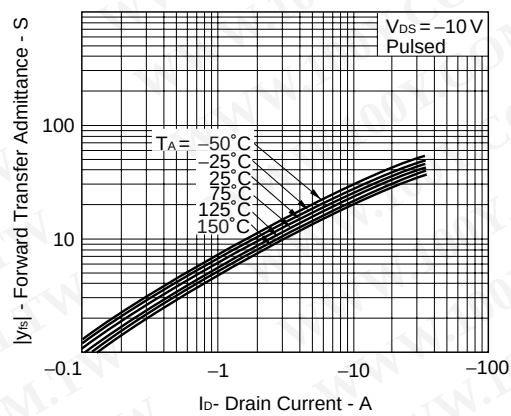
FORWARD TRANSFER CHARACTERISTICS



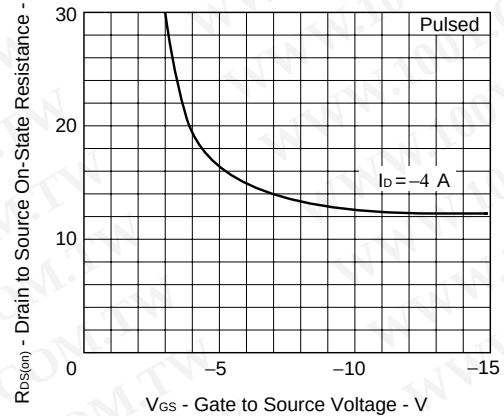
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



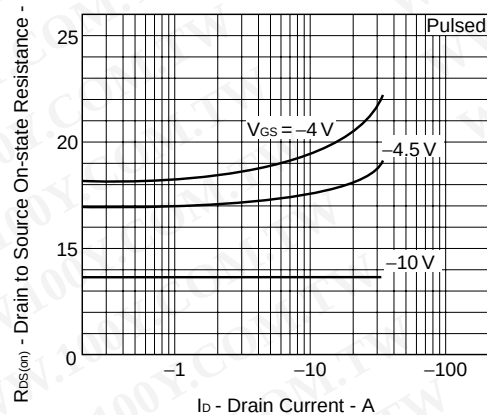
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



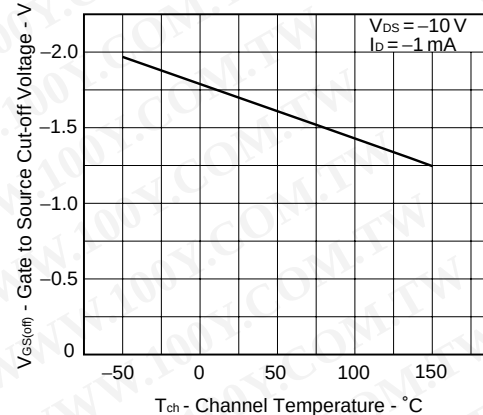
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

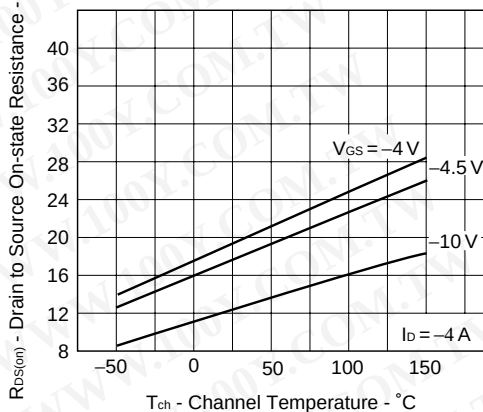


GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

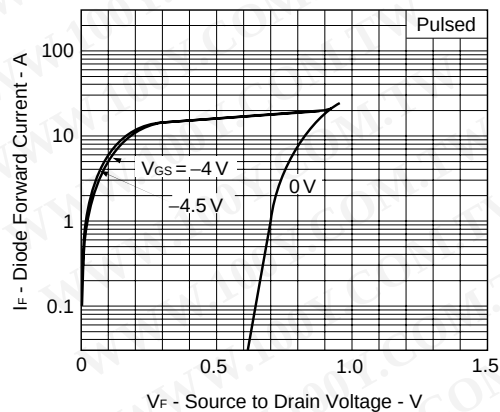


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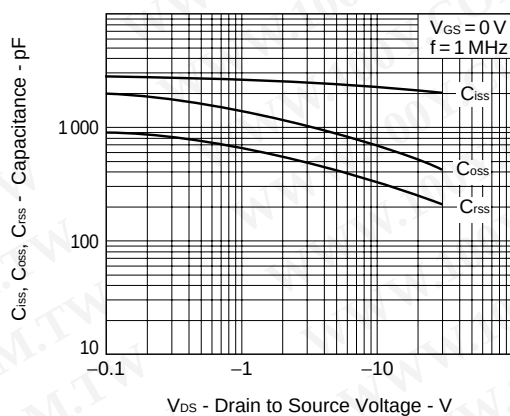
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



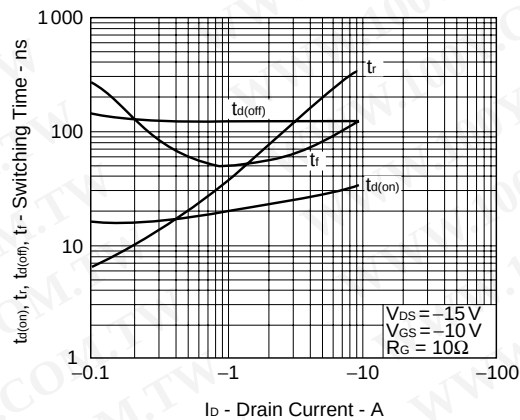
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



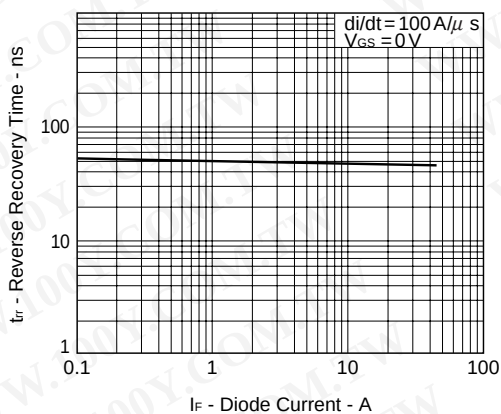
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



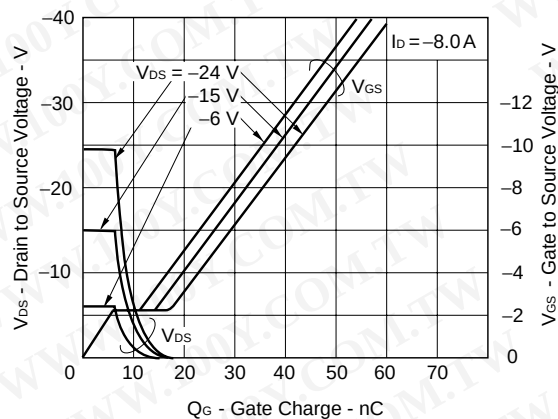
SWITCHING CHARACTERISTICS



REVERSE RECOVERY TIME vs. DIODE CURRENT



DYNAMIC INPUT/OUTPUT CHARACTERISTICS



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